

02-08-2007



1/29/07

F

T

103371071

To the Director of the U.S. Patent and Trademark Office. Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**

Kazunari Kurita

**2. Name and address of receiving party(ies)**

Name: Sumco Corporation

Internal Address: \_\_\_\_\_

Additional name(s) of conveying party(ies) attached?  Yes  No

**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) January 23, 2007

- Assignment  Merger
- Security Agreement  Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other \_\_\_\_\_

Street Address: 2-1, Shibaura 1-chome

City: Minato-ku

State: Tokyo

Country: Japan

Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

**4. Application or patent number(s):**

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

02/ 1/2007 HDEMSS1 00000003 11699894

01 C:8021

(40.00 OP)

Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**

Name: Anton E. Skaugset

Internal Address: Kolisch Hartwell, P.C.

Street Address: 520 S.W. Yamhill Street, Suite 200

City: Portland

State: Oregon

Zip: 97204

Phone Number: (503) 224-6655

Fax Number: (503) 295-6679

Email Address: anton@khpatent.com

**6. Total number of applications and patents involved: one**

**7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00**

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

**8. Payment Information**

a. Credit Card Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_

b. Deposit Account Number \_\_\_\_\_

Authorized User Name \_\_\_\_\_

**9. Signature:**

Anton E. Skaugset  
Signature

January 29, 2007  
Date

Anton E. Skaugset

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

113235 U.S. PTO  
11/699894

012907

CSP. 22054  
UF 議 1/2

ASSIGNMENT

WHEREAS, I/WE, **Kazunari KURITA**

Of c/o **SUMCO CORPORATION, 2-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan**

respectively, have invented certain improvements in  
SILICON WAFER AND METHOD FOR PRODUCING SAME

, for which we have executed an application for Letters Patent of the United States on the  
date we executed this Assignment as hereinafter set forth.

WHEREAS, **SUMCO CORPORATION**, a Japanese corporation, having its  
principal place of business in **Tokyo**, Japan, is desirous of acquiring an interest therein:

NOW, THEREFORE, for other good and valuable consideration, we the said  
**Kazunari KURITA**

, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer unto  
the said **SUMCO CORPORATION**, the full and exclusive right to the said invention in the  
United States and its territorial possessions and in all foreign countries and the entire right,  
title and interest in and to any and all Letters Patent which may be granted therefor in the  
United States and its territorial possessions in any and all foreign countries and in and to any  
and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office officials in the United  
States and any and all foreign countries to issue any and all of said Letters Patent, when  
granted, to the said **SUMCO CORPORATION**, as the assignee of our entire right, title and  
interest in and to the same, for the sole use of the said **SUMCO CORPORATION**, its

OSP-22054  
US(表)  
2/2

successors and assigns.

Further, we agree that we will communicate to the said **SUMCO CORPORATION**, or its representatives any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to the said **SUMCO CORPORATION**, make all rightful oaths and generally do everything possible to aid the said **SUMCO CORPORATION**, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 23rd day of January, 2007.

Kazunari Kurita  
FIRST INVENTOR **Kazunari KURITA**

Witness:

\_\_\_\_\_  
(Name)

\_\_\_\_\_  
(Address)

\_\_\_\_\_  
(City, Country)